



# Power MOSFETS

## DATASHEET

**LM7002KNEC3A**

N-Channel  
Enhancement Mode MOSFET

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Quality Management Systems  
ISO 9001:2015 Certificate

# LM7002KNEC3A

## N-Channel Enhancement Mode MOSFET

### Pin Description

SOT-523 (TOP view)	Symbol	Symbol	N-Channel	Unit
		$V_{DSS}$	60	V
		$R_{DS(ON)-Max}$	1.9	$\Omega$
		$I_D$	0.31	A

### Feature

- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- ESD Protection

### Ordering Information

### Applications

- Small signal application
- Load switch

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM7002KNEC3A	SOT-523	Tape & Reel	3000 / Tape & Reel	K□□

Note : □□ = Lot Code

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	60	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$I_{DM}^{\circledR}$	Pulse Drain Current Tested	$T_A=25^\circ\text{C}$	A
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{QJA}^{\circledR}$	Thermal Resistance-Junction to Ambient	Steady State	$^\circ\text{C/W}$

Note ① : Max. current is limited by junction temperature

Note ② : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

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## N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
<b><math>\text{BV}_{\text{DSS}}</math></b>	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{DS}}=250\mu\text{A}$	60	-	-	V
<b><math>I_{\text{DSS}}</math></b>	Zero Gate Voltage Drain Current	$V_{\text{DS}}=48\text{V}$ , $V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
<b><math>V_{\text{GS(th)}}</math></b>	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{DS}}=250\mu\text{A}$	1	1.6	2.5	V
<b><math>I_{\text{GSS}}</math></b>	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	-	-	$\pm 10$	$\mu\text{A}$
<b><math>R_{\text{DS(ON)}}^{\circledast}</math></b>	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{DS}}=0.3\text{A}$	-	1.6	1.9	$\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{DS}}=0.2\text{A}$	-	1.7	2.2	
<b><math>g_{\text{fs}}</math></b>	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_{\text{DS}}=0.2\text{A}$	-	0.45	-	S
<b>Dynamic Characteristics <sup>④</sup></b>						
<b><math>C_{\text{iss}}</math></b>	Input Capacitance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=30\text{V}$ , Freq.=1MHz	-	26.5	-	pF
<b><math>C_{\text{oss}}</math></b>	Output Capacitance		-	2.7	-	
<b><math>C_{\text{rss}}</math></b>	Reverse Transfer Capacitance		-	1.7	-	
<b><math>t_{\text{d(ON)}}</math></b>	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=30\text{V}$ , $I_{\text{D}}=0.3\text{A}$ , $R_{\text{GEN}}=10\Omega$	-	1	-	nS
<b><math>t_{\text{r}}</math></b>	Turn-on Rise Time		-	19.5	-	
<b><math>t_{\text{d(OFF)}}</math></b>	Turn-off Delay Time		-	23	-	
<b><math>t_{\text{f}}</math></b>	Turn-off Fall Time		-	21	-	
<b><math>Q_{\text{g}}</math></b>	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}$ , $V_{\text{DS}}=30\text{V}$ $I_{\text{D}}=1\text{A}$	-	0.9	-	nC
<b><math>Q_{\text{g}}</math></b>	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=30\text{V}$ , $I_{\text{D}}=1\text{A}$	-	1.7	-	
<b><math>Q_{\text{gs}}</math></b>	Gate-Source Charge		-	0.4	-	
<b><math>Q_{\text{gd}}</math></b>	Gate-Drain Charge		-	0.3	-	
<b>Source-Drain Characteristics</b>						
<b><math>V_{\text{SD}}^{\circledast}</math></b>	Diode Forward Voltage	$I_{\text{SD}}=0.1\text{A}$ , $V_{\text{GS}}=0\text{V}$	-	0.8	1.1	V
<b><math>t_{\text{rr}}</math></b>	Reverse Recovery Time	$I_{\text{F}}=0.1\text{A}$ , $V_{\text{R}}=0\text{V}$	-	7.5	-	nS
<b><math>Q_{\text{rr}}</math></b>	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	2.3	-	nC

Note ③ : Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

Note ④ : Guaranteed by design, not subject to production testing.

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## N-Channel Typical Characteristics

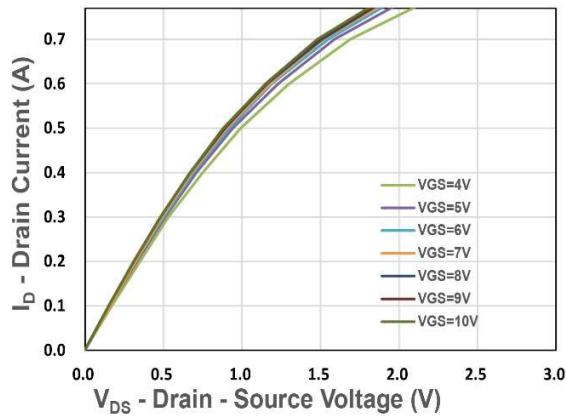


Figure 1. Output Characteristics

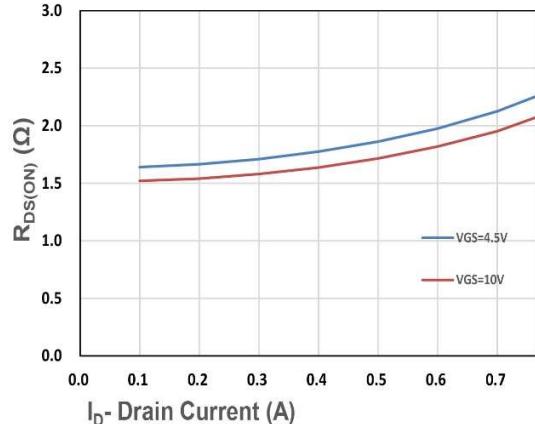


Figure 2. On-Resistance vs. ID

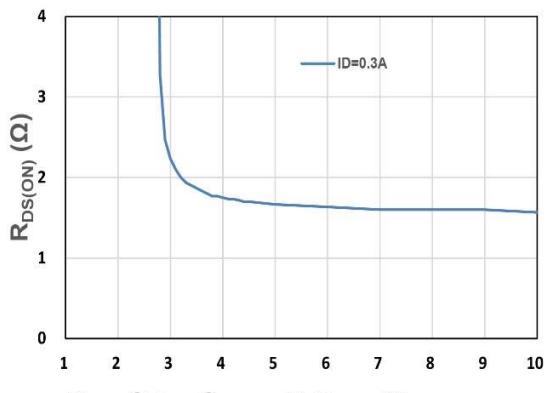


Figure 3. On-Resistance vs. VGS

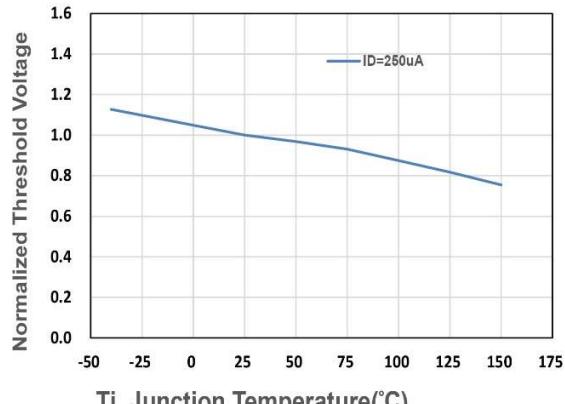


Figure 4. Gate Threshold Voltage

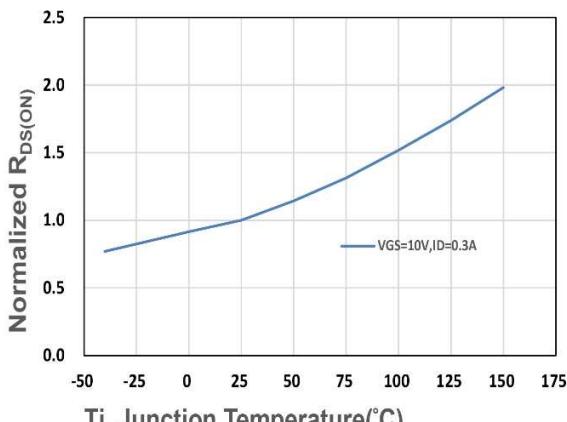


Figure 5. Drain-Source On Resistance

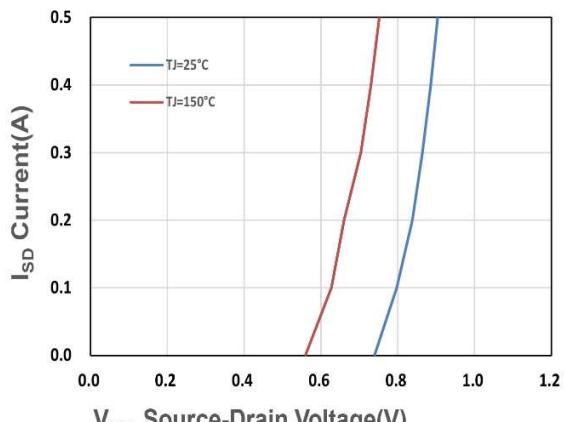


Figure 6. Source-Drain Diode Forward

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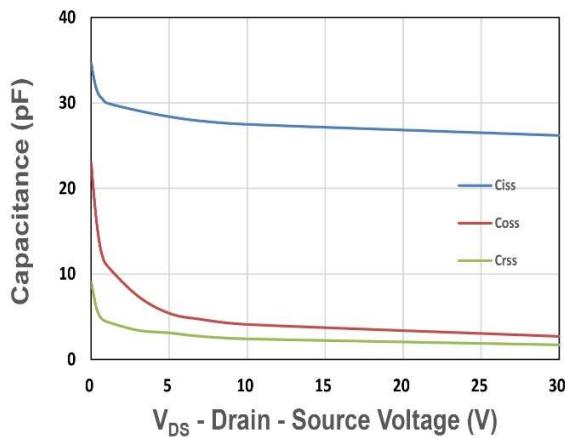


Figure 7. Capacitance

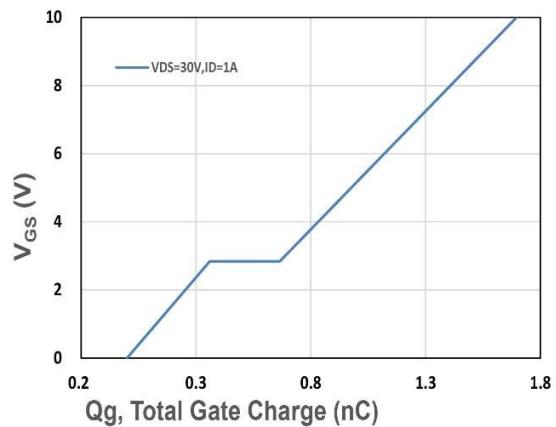


Figure 8. Gate Charge Characteristics

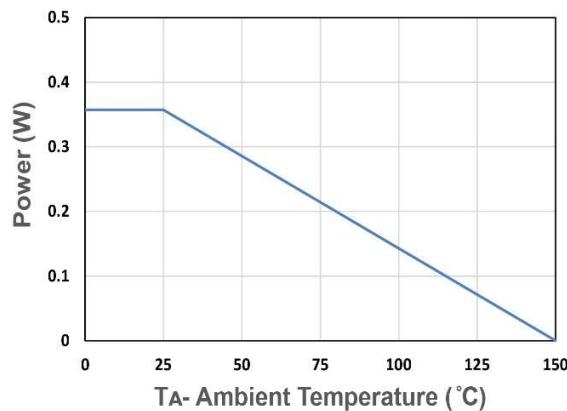


Figure 9. Power Dissipation

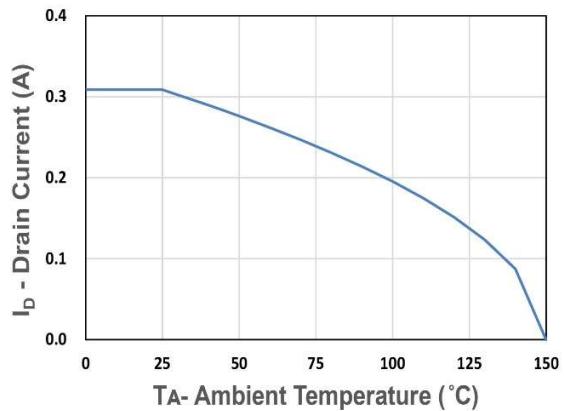


Figure 10. Drain Current

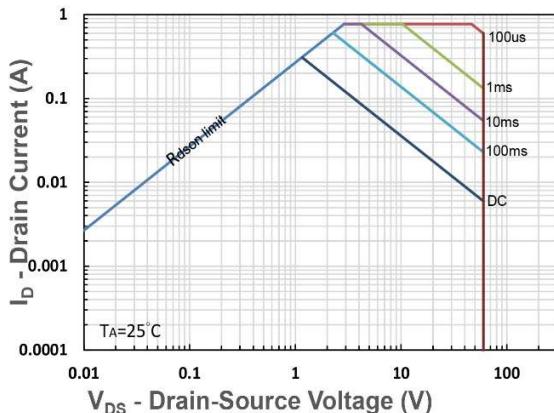


Figure 11. Safe Operating Area

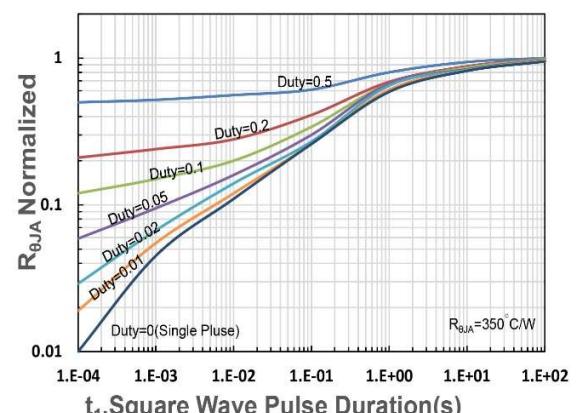


Figure 12. R<sub>θJA</sub> Transient Thermal Impedance